

View Online at <https://aerobasegroup.com/nsn/5910-01-233-4243>

**Body Style:**

Chip typechip type

**Reliability Indicator:**

Establishedestablished

**Reliability Failure Rate Level In Percent:**

0.1000.100

**Terminal Length:**

0.030 inches 0.030 inches

**Body Length:**

0.100 inches

**Body Width:**

0.050 inches

**Body Height:**

0.050 inches

**Schematic Diagram Designator:**

No common or grounded electrode (s)

**Electrical Polarization:**

Polarized

**End Application:**

1260-01-208-6448 mast mounted si

**Capacitance Value Per Section:**

1.000 microfarads single section

**Nonderated Operating Temp:**

Between -55.0 degrees celsius and 85.0 degrees celsius

**Dc Leakage At Maximum Operating Temp:**

10.0 microamperes

**Nonderated Continuous Voltage Rating And Type Per Section:**

10.0 dc single section

**Tolerance Range Per Section:**

-10.00/+10.00 percent single section

**Case Material:**

Ceramic

**Capacitive Electrode Material:**

Tantalum

**Dissipation Factor At Reference Temperature In Percent:**

6.000

**Dc Leakage At Reference Temp:**

1.000 microamperes

**Terminal Surface Treatment:**

Gold

**Precious Material And Location:**

Terminal surfaces gold

**Test Data Document:**

81349-mil-c-55365 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).

**Terminal Type And Quantity:**

2 bonding pad

**Specification Data:**

81349-mil-c-55365/4 government specification

**Shelf Life:**

N/a

**Unit Of Measure:**

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**Demilitarization:**

No

**Fig:**

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